

# MITSUBISHI HIGH SPEED CMOS M74HC375P/FP/DP

## DUAL 2-BIT TRANSPARENT LATCH

### DESCRIPTION

The M74HC375 is a semiconductor integrated circuit consisting of four bistable latches with outputs Q and  $\bar{Q}$ .

### FEATURES

- High-speed: 14ns typ. ( $C_L=15\text{pF}$ ,  $V_{CC}=5\text{V}$ )
- Low power dissipation:  $10\mu\text{W}/\text{package}$ , max ( $V_{CC}=5\text{V}$ ,  $T_a=25^\circ\text{C}$ , quiescent state)
- High noise margin: 30% of  $V_{CC}$ , min ( $V_{CC}=4.5\text{V}$ , 6V)
- Capable of driving 10 74LSTTL loads
- Wide operating voltage range:  $V_{CC}=2\sim 6\text{V}$
- Wide operating temperature range:  $T_a=-40\sim +85^\circ\text{C}$

### APPLICATION

General purpose, for use in industrial and consumer digital equipment.

### FUNCTIONAL DESCRIPTION

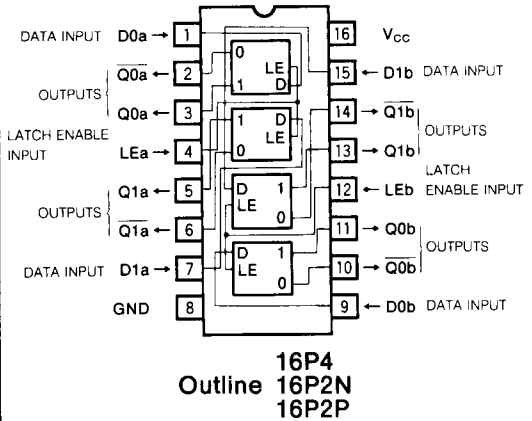
Use of silicon gate technology allows the M74HC375 to maintain the low power dissipation and high noise margin characteristics of the standard CMOS logic 4000B series while giving high-speed performance equivalent to the 74LS375.

The use of buffered outputs improves the input-to output transfer characteristics and minimizes output impedance variations with respect to input voltage variations.

The M74HC375 has four D-type latches, and is provided with enable inputs LE common to two circuits each. When LE is high, the information from the data input D will appear in the outputs Q and  $\bar{Q}$ . When the D signal changes, the signal that appears in outputs Q and  $\bar{Q}$  also will change. When LE changes from high to low, the status of D immediately before the change will be latched. When LE is low, Q and  $\bar{Q}$  will not change even if D changes.

A unit, the M74HC75, having the same functions and electrical characteristics as the M74HC375 is also available.

### PIN CONFIGURATION (TOP VIEW)

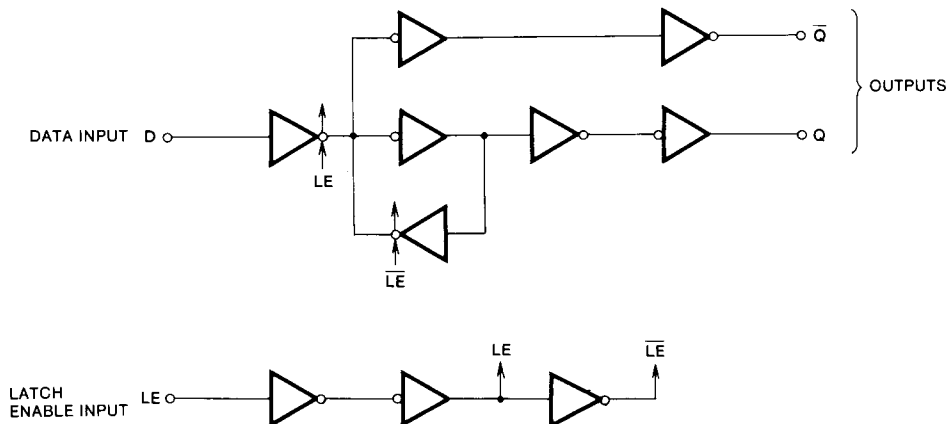


### FUNCTION TABLE (Note 1)

Inputs		Outputs	
LE	D	Q	$\bar{Q}$
H	H	H	L
H	L	L	H
L	X	$Q^0$	$\bar{Q}^0$

Note 1 :  $Q^0$ ,  $\bar{Q}^0$  : Output state Q,  $\bar{Q}$  before input condition is set  
X : Irrelevant

### LOGIC DIAGRAM (EACH LATCH)



DUAL 2-BIT TRANSPARENT LATCH

ABSOLUTE MAXIMUM RATINGS ( $T_a = -40 \sim +85^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{CC}$	Supply voltage		$-0.5 \sim +7.0$	V
$V_i$	Input voltage		$-0.5 \sim V_{CC} + 0.5$	V
$V_o$	Output voltage		$-0.5 \sim V_{CC} + 0.5$	V
$I_{IK}$	Input protection diode current	$V_i < 0V$	-20	mA
		$V_i > V_{CC}$	20	
$I_{OK}$	Output parasitic diode current	$V_o < 0V$	-20	mA
		$V_o > V_{CC}$	20	
$I_o$	Output current per output pin		$\pm 25$	mA
$I_{CC}$	Supply/GND current	$V_{CC}, GND$	$\pm 50$	mA
$P_d$	Power dissipation	(Note 2)	500	mW
$T_{stg}$	Storage temperature range		$-65 \sim +150$	$^\circ\text{C}$

Note 2 : M74HC375FP,  $T_a = -40 \sim +70^\circ\text{C}$  and  $T_a = 70 \sim 85^\circ\text{C}$  are derated at  $-6\text{mW}/^\circ\text{C}$ .  
M74HC375DP,  $T_a = -40 \sim +50^\circ\text{C}$  and  $T_a = 50 \sim 85^\circ\text{C}$  are derated at  $-5\text{mW}/^\circ\text{C}$ .

RECOMMENDED OPERATING CONDITIONS ( $T_a = -40 \sim +85^\circ\text{C}$ )

Symbol	Parameter	Limits			Unit
		Min	Typ	Max	
$V_{CC}$	Supply voltage	2		6	V
$V_i$	Input voltage	0		$V_{CC}$	V
$V_o$	Output voltage	0		$V_{CC}$	V
$T_{opr}$	Operating temperature range	-40		+85	$^\circ\text{C}$
$t_r, t_f$	Input risetime, falltime	$V_{CC} = 2.0V$	0	1000	ns
		$V_{CC} = 4.5V$	0	500	
		$V_{CC} = 6.0V$	0	400	

ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test conditions	Limits					Unit	
			$V_{CC}(V)$	25 $^\circ\text{C}$			$-40 \sim +85^\circ\text{C}$		
				Min	Typ	Max	Min		Max
$V_{IH}$	High-level input voltage	$V_o = 0.1V, V_{CC} = 0.1V$ $ I_o  = 20\mu A$	2.0	1.5			1.5	V	
			4.5	3.15			3.15		
			6.0	4.2			4.2		
$V_{IL}$	Low-level input voltage	$V_o = 0.1V, V_{CC} = 0.1V$ $ I_o  = 20\mu A$	2.0			0.5	0.5	V	
			4.5			1.35	1.35		
			6.0			1.8	1.8		
$V_{OH}$	High-level output voltage	$V_i = V_{IH}, V_{IL}$	$I_{OH} = -20\mu A$	2.0	1.9		1.9	V	
			$I_{OH} = -20\mu A$	4.5	4.4		4.4		
			$I_{OH} = -20\mu A$	6.0	5.9		5.9		
			$I_{OH} = -4.0mA$	4.5	4.18		4.13		
			$I_{OH} = -5.2mA$	6.0	5.68		5.63		
$V_{OL}$	Low-level output voltage	$V_i = V_{IH}, V_{IL}$	$I_{OL} = 20\mu A$	2.0		0.1	0.1	V	
			$I_{OL} = 20\mu A$	4.5		0.1	0.1		
			$I_{OL} = 20\mu A$	6.0		0.1	0.1		
			$I_{OL} = 4.0mA$	4.5		0.26	0.33		
			$I_{OL} = 5.2mA$	6.0		0.26	0.33		
$I_{IH}$	High-level input current	$V_i = 6V$	6.0		0.1	1.0	$\mu A$		
$I_{IL}$	Low-level input current	$V_i = 0V$	6.0		-0.1	-1.0	$\mu A$		
$I_{CC}$	Quiescent supply current	$V_i = V_{CC}, GND, I_o = 0\mu A$	6.0		2.0	20.0	$\mu A$		

DUAL 2-BIT TRANSPARENT LATCH

SWITCHING CHARACTERISTICS ( $V_{CC} = 5V, T_a = 25^\circ C$ )

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$t_{TLH}$	Low-level to high-level and high-level to low-level output transition time	$C_L = 15pF$ (Note 4)			10	ns
$t_{THL}$					10	ns
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (D - Q)				23	ns
$t_{PHL}$					23	ns
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (D - $\bar{Q}$ )				20	ns
$t_{PHL}$					20	ns
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (LE - Q)				27	ns
$t_{PHL}$					27	ns
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (LE - $\bar{Q}$ )				23	ns
$t_{PHL}$					23	ns

SWITCHING CHARACTERISTICS ( $V_{CC} = 2\sim 6V, T_a = -40\sim +85^\circ C$ )

Symbol	Parameter	Test conditions	Limits						Unit
			$V_{CC}(V)$	25°C			-40~+85°C		
				Min	Typ	Max	Min	Max	
$t_{TLH}$	Low-level to high-level and high-level to low-level output transition time	$C_L = 50pF$ (Note 4)	2.0			75		95	ns
			4.5			15		19	
			6.0			13		16	
$t_{THL}$	output transition time		2.0			75		95	ns
			4.5			15		19	
			6.0			13		16	
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (D - Q)		2.0			125		156	ns
			4.5			25		32	
			6.0			21		27	
$t_{PHL}$	output propagation time (D - $\bar{Q}$ )		2.0			125		156	ns
			4.5			25		32	
			6.0			21		27	
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (D - Q)		2.0			110		138	ns
			4.5			22		28	
			6.0			19		24	
$t_{PHL}$	output propagation time (D - $\bar{Q}$ )		2.0			110		138	ns
			4.5			22		28	
			6.0			19		24	
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (LE - Q)	2.0			145		181	ns	
		4.5			29		36		
		6.0			25		31		
$t_{PHL}$	output propagation time (LE - $\bar{Q}$ )	2.0			145		181	ns	
		4.5			29		36		
		6.0			25		31		
$t_{PLH}$	Low-level to high-level and high-level to low-level output propagation time (LE - Q)	2.0			125		156	ns	
		4.5			25		31		
		6.0			22		28		
$t_{PHL}$	output propagation time (LE - $\bar{Q}$ )	2.0			125		156	ns	
		4.5			25		31		
		6.0			22		28		
$C_i$	Input capacitance				10		10	pF	
$C_{PD}$	Power dissipation capacitance (Note 3)			66				pF	

Note 3 :  $C_{PD}$  is the internal capacitance of the IC calculated from operation supply current under no-load conditions. (per latch)  
The power dissipated during operation under no-load conditions is calculated using the following formula:  
 $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_i + I_{CC} \cdot V_{CC}$

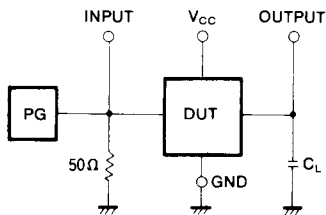
# MITSUBISHI HIGH SPEED CMOS M74HC375P/FP/DP

## DUAL 2-BIT TRANSPARENT LATCH

### TIMING REQUIREMENTS ( $V_{CC} = 2\sim 6V$ , $T_a = -40\sim +85^\circ C$ )

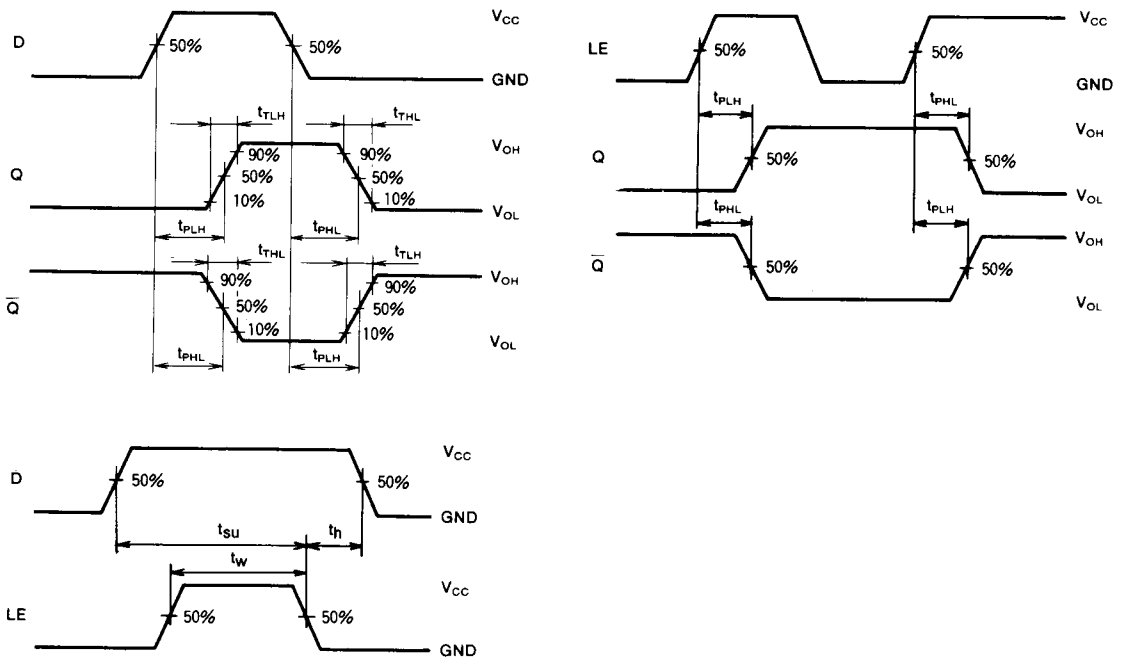
Symbol	Parameter	Test conditions	Limits						Unit
			$V_{CC}(V)$	25°C			-40~+85°C		
				Min	Typ	Max	Min	Max	
$t_w$	LE pulse width		2.0	80			100		ns
			4.5	16			20		
			6.0	14			18		
$t_{su}$	D setup time with respect to LE		2.0	100			125		ns
			4.5	20			25		
			6.0	17			21		
$t_h$	D hold time with respect to LE		2.0	5			5		ns
			4.5	5			5		
			6.0	5			5		

Note 4 : Test Circuit



- (1) The pulse generator (PG) has the following characteristics (10%~90%):  $t_r = 6ns$ ,  $t_f = 6ns$
- (2) The capacitance  $C_L$  includes stray wiring capacitance and the probe input capacitance.

### TIMING DIAGRAM



MITSUBISHI HIGH SPEED CMOS  
PACKAGE OUTLINES

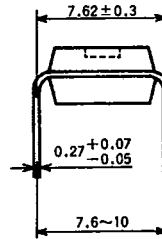
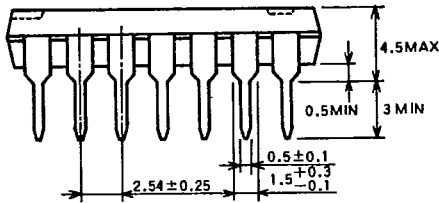
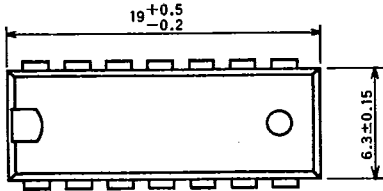
6249827 MITSUBISHI (DGTL LOGIC)

91D 12849

D T-90-20

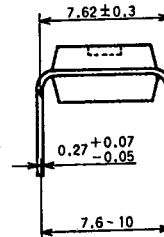
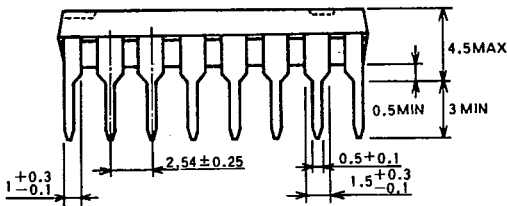
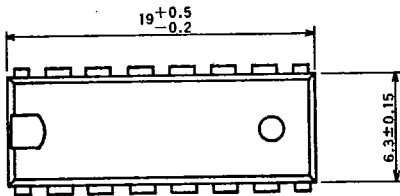
TYPE 14P4 14-PIN MOLDED PLASTIC DIP

Dimension in mm



TYPE 16P4 16-PIN MOLDED PLASTIC DIP

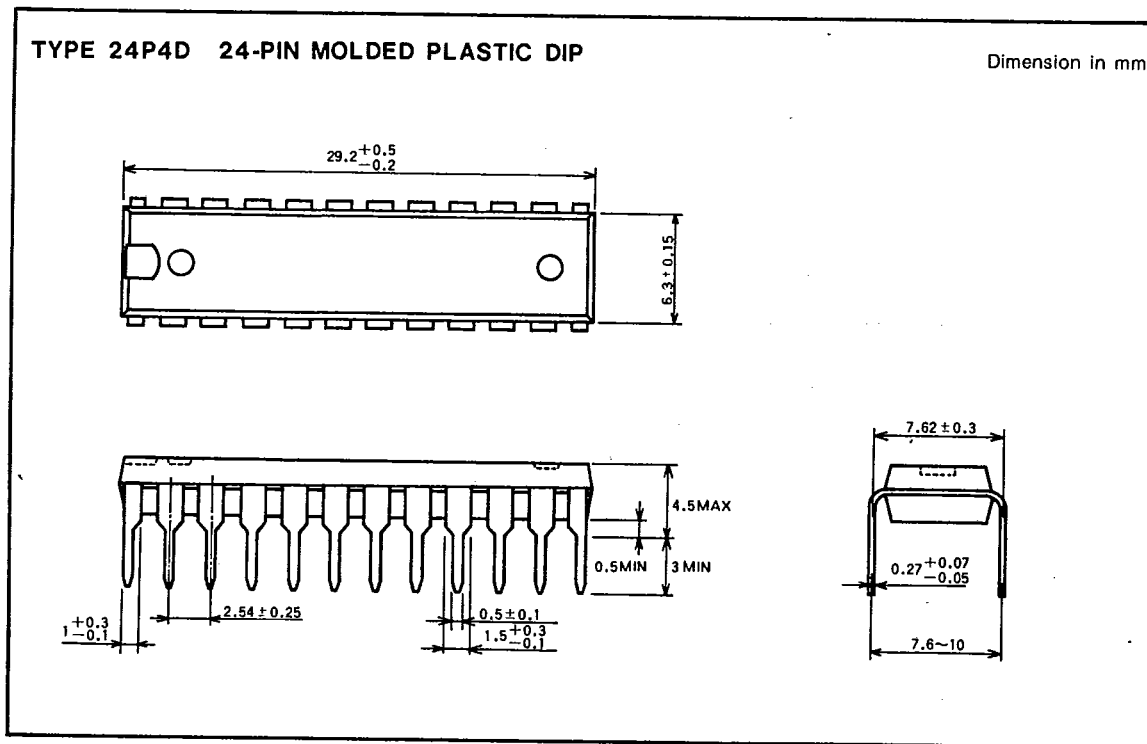
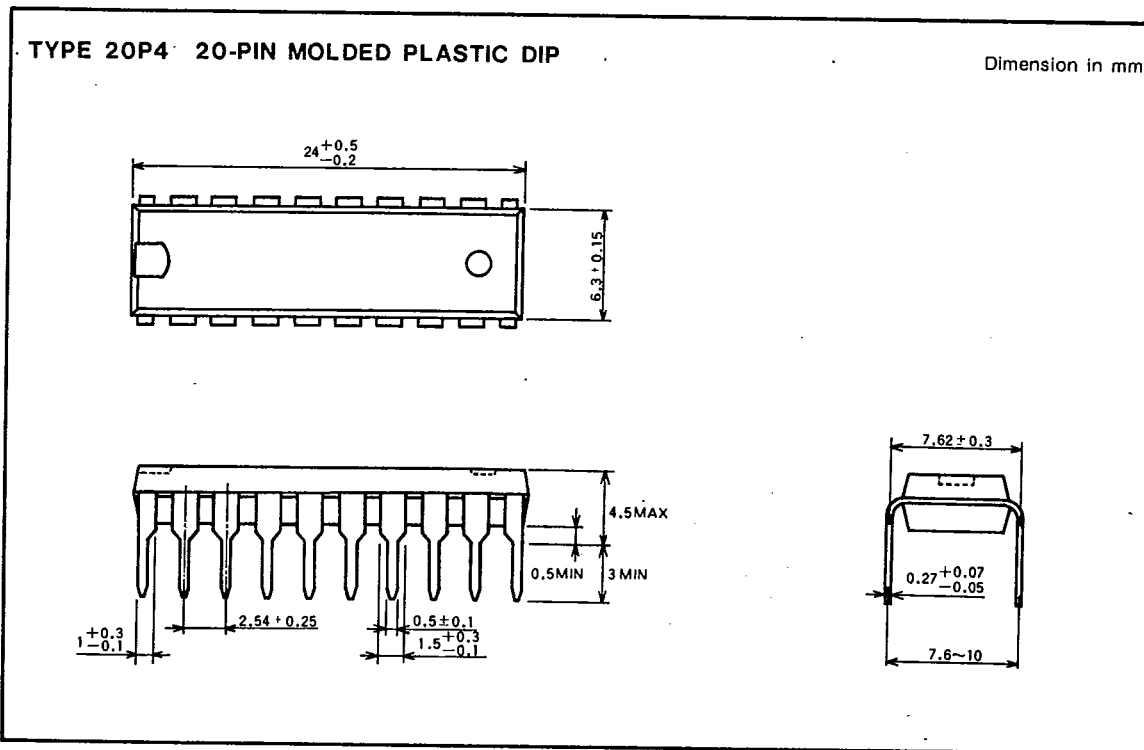
Dimension in mm



MITSUBISHI HIGH SPEED CMOS  
**PACKAGE OUTLINES**

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91D 12850 D.T-90-20



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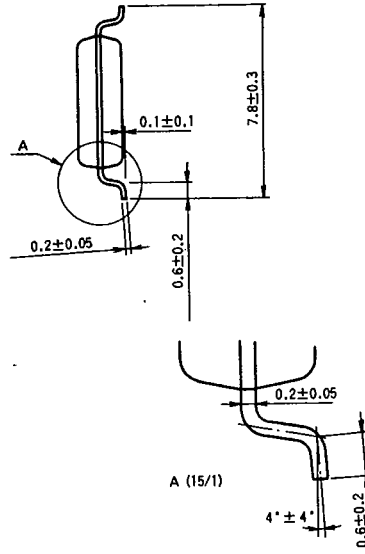
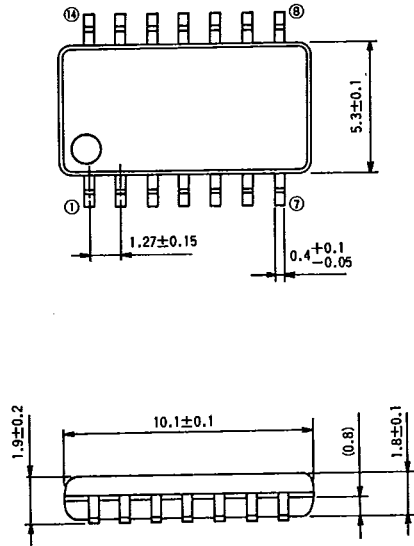
MITSUBISHI HIGH SPEED CMOS  
PACKAGE OUTLINES

6249827 MITSUBISHI (DGTL LOGIC)

91D 12851 D T-90.20

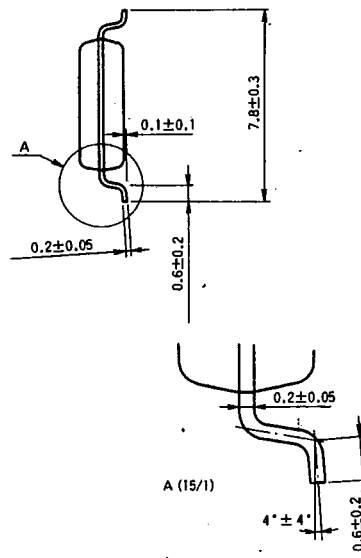
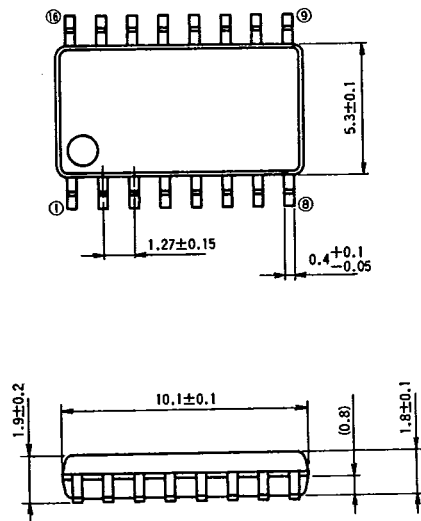
TYPE 14P2N 14PIN MOLDED PLASTIC SOP

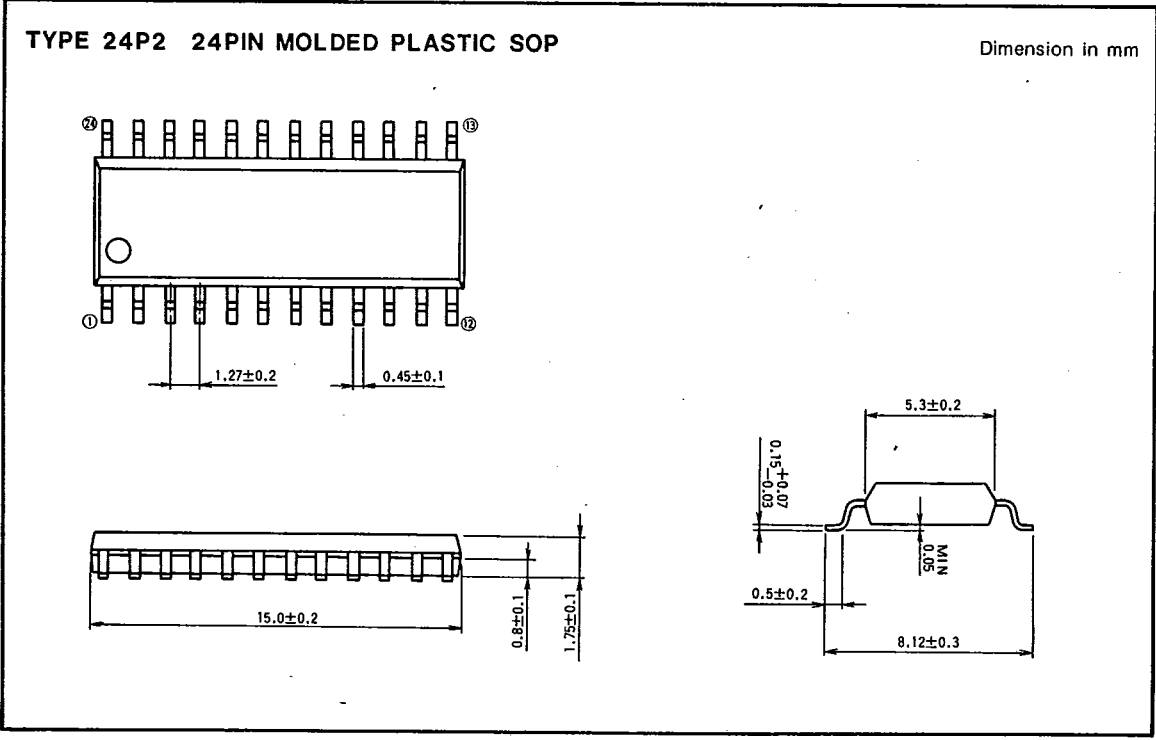
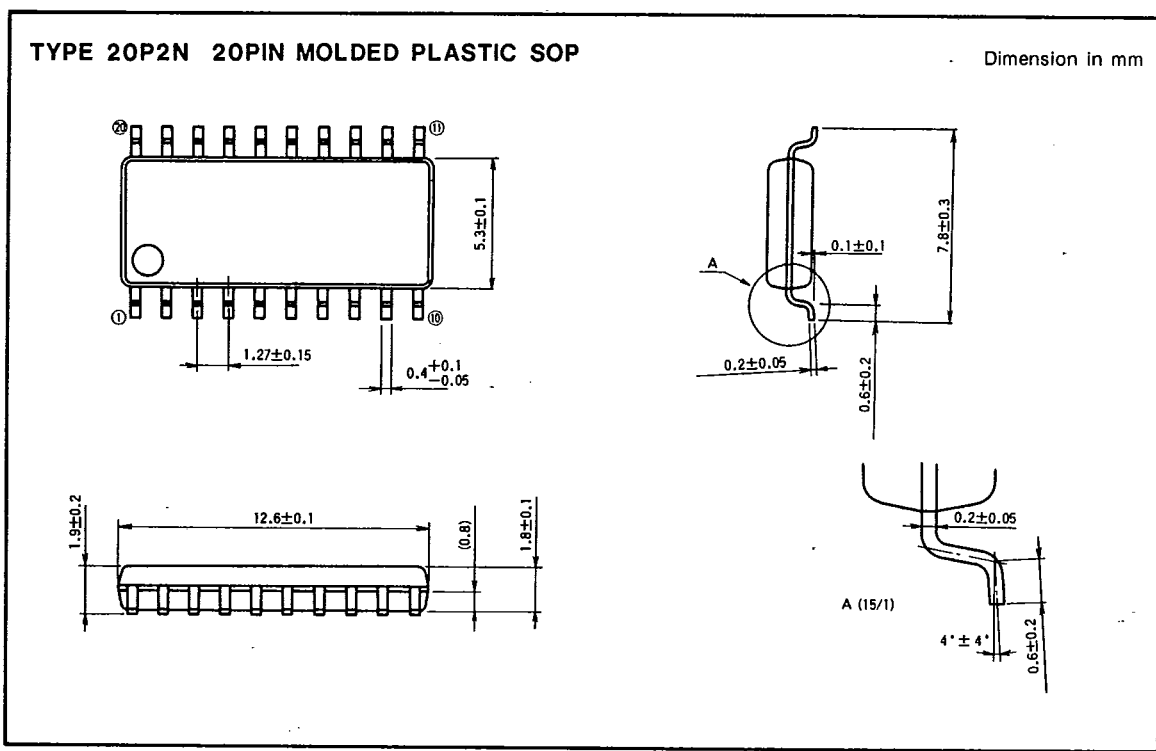
Dimension in mm



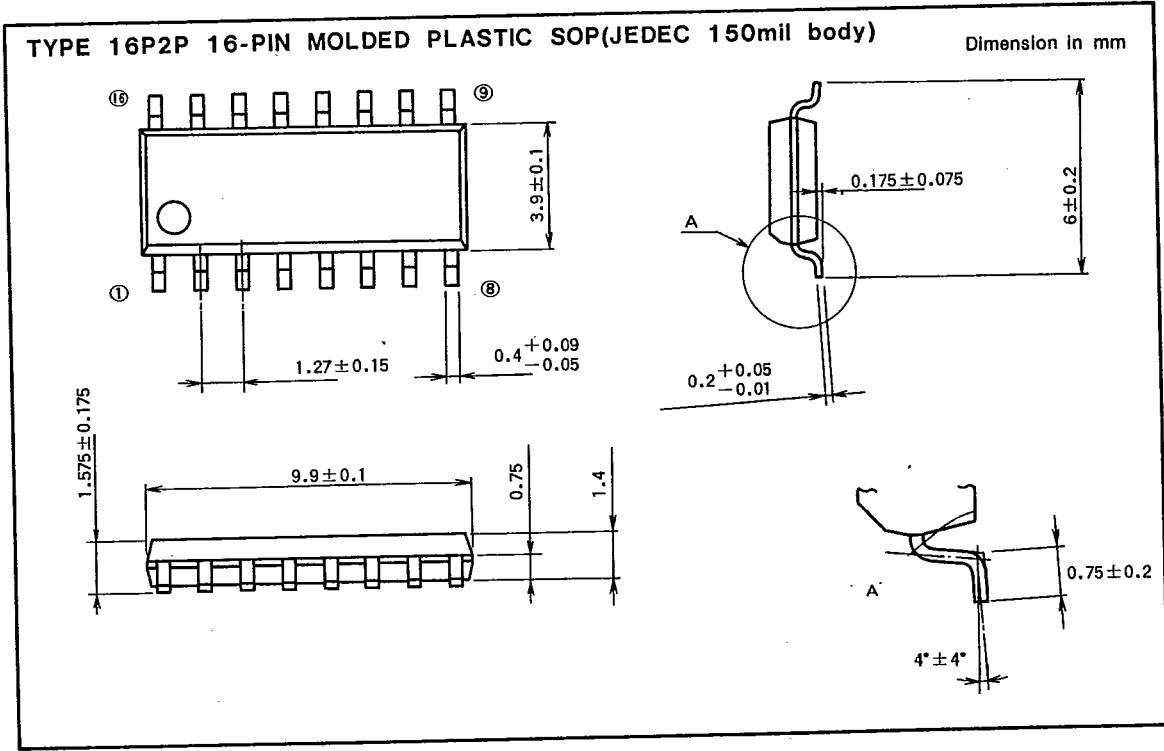
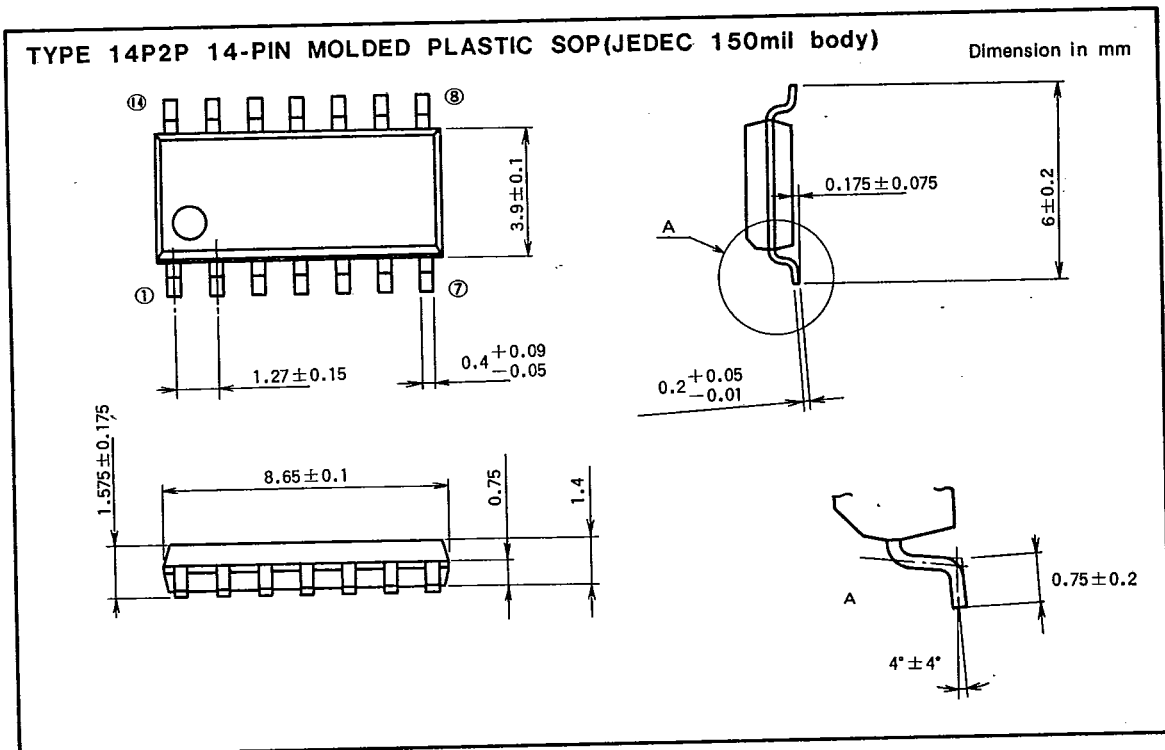
TYPE 16P2N 16PIN MOLDED PLASTIC SOP

Dimension in mm









MITSUBISHI HIGH SPEED CMOS  
PACKAGE OUTLINES

6249827 MITSUBISHI (DGTL LOGIC)

91D 12854 D T-90-20

